



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



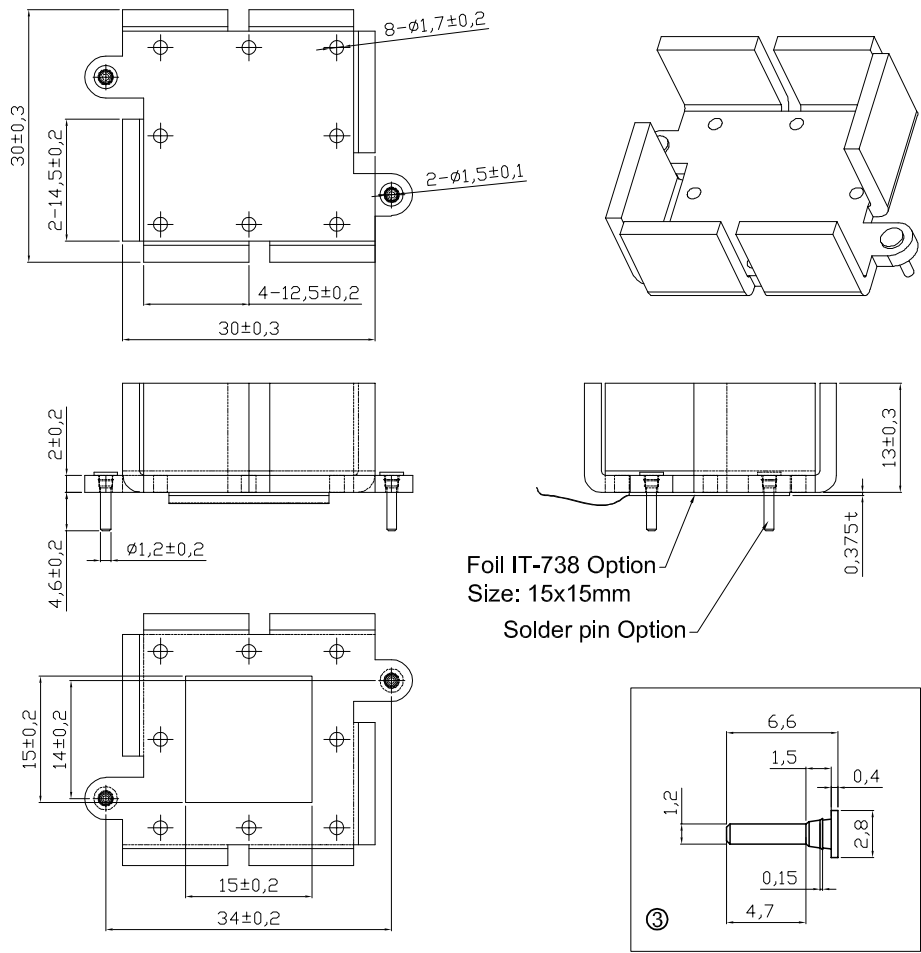
Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

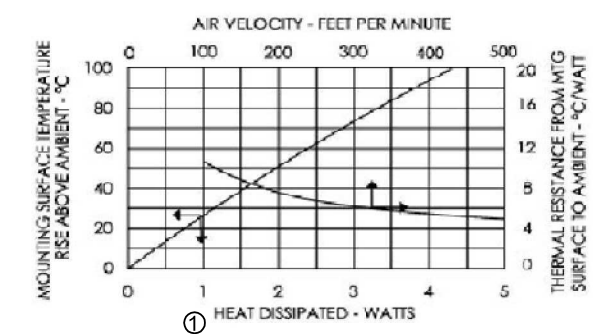
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





Foil IT-738 Option
Size: 15x15mm
Solder pin Option



Note:
Material: AL 1050
Finish: Nature anodized
Pin: Fe, Tin plated
② Recommended IC size: ≤25x25mm
Recommended IC power: ≤4W

WSW order code:
V2200N1: w/o foil and solder pin
V2200N1-F: with foil , w/o solder pin
V2200N1-LP: w/o foil , with solder pin
V2200N1-F-LP: with foil and solder pin

RoHS compliant
Unit: mm

Scale	Free					Date	Name	Customer-No.	
③	TOLERANCE					Drawn	25.01.2016	Amy	
	Less 10	±0.10							
	10~30	±0.20	③	Update tolerance and add pin	30.05.2018	Segal	Approved	30.05.2018	Amy
	31~50	±0.30	②	Add IC size and power in notes	22.05.2018	Amy			
	51~120	±0.50	①	Add thermal resistance graph	19.02.2016	Amy			
	DIM	Tol	①	Drawn	25.01.2016	Amy			
	Angle	±1°	Id.	Modification	Date	Name			



Customer-No.		V2200N1-x
ASSMANN WSW-No.		
Drawing-No.		ASS 4263 HS
rev03		
Replace	Sheet	1 / 2

1

2

3

4

5


6

7

KT2113

A	IT-738 Thermally Conductive Attachment Tape						A
	Item	IT-738	Test Method				
	Color	White	Visual				
B	Thickness	0.375mm	ASTM D374				
	Thickness tolerance	±10%	/				
	Construction & Composition	High performance Ceramic filled acrylic pressure-sensitive adhesive	Visual				
C	Thermal Conductivity (W/mk)	1.2	ASTM D5470				
	Peel Strength 90° on aluminum	3000 g	ASTM D1000				
D	Holding Power 1kg@Room Temp using 1 in ²	1 week PASS	PSTC-107				
	Dielectric Strength	668 Volts/mil	ASTM D-149				
	Holding Power 500g@70°C using 1 in ²	1 week PASS	PSTC-107				
E	Continuous Use Temp	-30°C to 150°C	/				
	Voltage Breakdown	>5KV	SSTM D149				
	RoHS Compliant	YES	SGS				
F	REACH Compliant	YES	SGS				
	Flammability Rating	V-0	UL 94				

RoHS compliant
Unit: mm

G	Scale	Free				Date	Name	Customer-No.
	③ TOLERANCE					Drawn	Amy	
	Less 10	±0.15						
	10~30	±0.20	③ Update tolerance and add pin	30.05.2018	Segal	Approved	Amy	ASSMANN WSW-No.
	31~50	±0.30	② Add IC size and power in notes	22.05.2018	Amy			V2200N1-x
	51~120	±0.50	① Add thermal resistance graph	19.02.2016	Amy			Drawing-No.
H	DIM	Tol	① Drawn	25.01.2016	Amy			ASS 4263 HS
	Angle	±1°	Id.	Modification	Date	Name	Replace	rev03
								Sheet 2 / 2